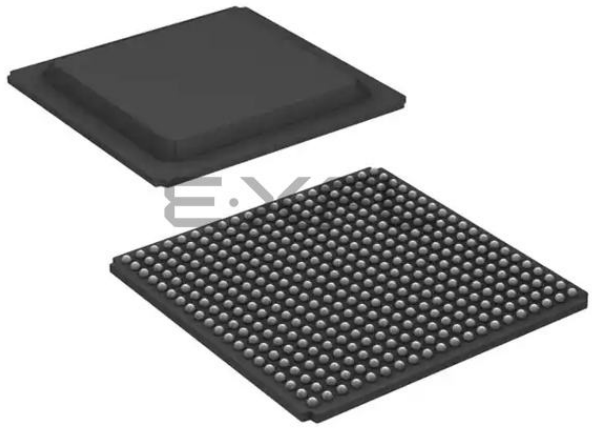

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The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	1472
Number of Logic Elements/Cells	13248
Total RAM Bits	368640
Number of I/O	311
Number of Gates	700000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	400-BGA
Supplier Device Package	400-FBGA (21x21)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s700a-4fgg400i

Related Product Families

The Spartan-3AN nonvolatile FPGA family is architecturally identical to the Spartan-3A FPGA family, except that it has in-system flash memory and is offered in select pin-compatible package options.

- **DS557: Spartan-3AN Family Data Sheet**
  www.xilinx.com/support/documentation/data_sheets/ds557.pdf

The compatible Spartan-3A DSP FPGA family replaces the 18-bit multiplier with the DSP48A block, while also increasing the block RAM capability and quantity. The two members of the Spartan-3A DSP FPGA family extend the Spartan-3A density range up to 37,440 and 53,712 logic cells.

- **DS610: Spartan-3A DSP FPGA Family Data Sheet**
  www.xilinx.com/support/documentation/data_sheets/ds610.pdf
- **UG431: XtremeDSP DSP48A for Spartan-3A DSP FPGAs**
  www.xilinx.com/support/documentation/user_guides/ug431.pdf

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status.
03/16/07	1.2	Added cross-reference to nonvolatile Spartan-3AN FPGA family.
04/23/07	1.3	Added cross-reference to compatible Spartan-3A DSP family.
07/10/07	1.4	Updated Starter Kit reference to new UG334.
04/15/08	1.6	Updated trademarks.
05/28/08	1.7	Added reference to XA Automotive version.
03/06/09	1.8	Added link to DS706 on Extended Spartan-3A family.
08/19/10	2.0	Updated link to sign up for Alerts.

Differential I/O Standards

Differential Input Pairs

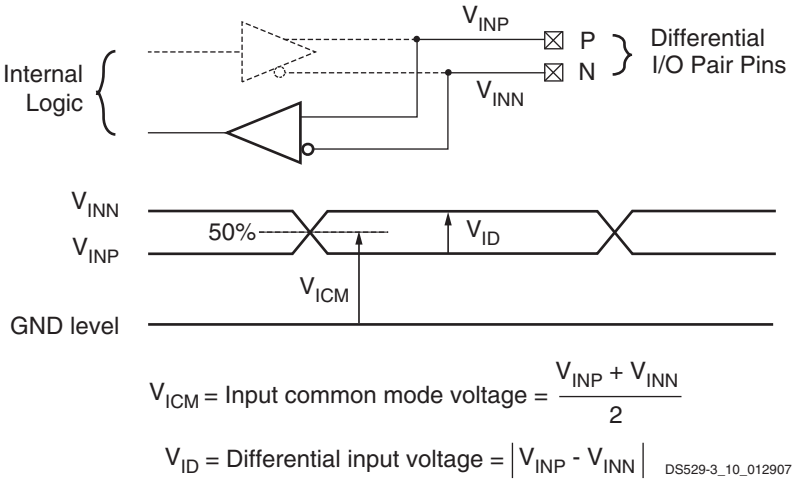


Figure 4: **Differential Input Voltages**

Table 13: **Recommended Operating Conditions for User I/Os Using Differential Signal Standards**

IOSTANDARD Attribute	V_{CCO} for Drivers(1)			V_{ID}			V_{ICM}(2)		
	Min (V)	Nom (V)	Max (V)	Min (mV)	Nom (mV)	Max (mV)	Min (V)	Nom (V)	Max (V)
LVDS_25(3)	2.25	2.5	2.75	100	350	600	0.3	1.25	2.35
LVDS_33(3)	3.0	3.3	3.6	100	350	600	0.3	1.25	2.35
BLVDS_25(4)	2.25	2.5	2.75	100	300	–	0.3	1.3	2.35
MINI_LVDS_25(3)	2.25	2.5	2.75	200	–	600	0.3	1.2	1.95
MINI_LVDS_33(3)	3.0	3.3	3.6	200	–	600	0.3	1.2	1.95
LVPECL_25(5)	Inputs Only			100	800	1000	0.3	1.2	1.95
LVPECL_33(5)	Inputs Only			100	800	1000	0.3	1.2	2.8(6)
RSDS_25(3)	2.25	2.5	2.75	100	200	–	0.3	1.2	1.5
RSDS_33(3)	3.0	3.3	3.6	100	200	–	0.3	1.2	1.5
TMDS_33(3, 4, 7)	3.14	3.3	3.47	150	–	1200	2.7	–	3.23
PPDS_25(3)	2.25	2.5	2.75	100	–	400	0.2	–	2.3
PPDS_33(3)	3.0	3.3	3.6	100	–	400	0.2	–	2.3
DIFF_HSTL_I_18	1.7	1.8	1.9	100	–	–	0.8	–	1.1
DIFF_HSTL_II_18(8)	1.7	1.8	1.9	100	–	–	0.8	–	1.1
DIFF_HSTL_III_18	1.7	1.8	1.9	100	–	–	0.8	–	1.1
DIFF_HSTL_I	1.4	1.5	1.6	100	–	–	0.68		0.9
DIFF_HSTL_III	1.4	1.5	1.6	100	–	–	–	0.9	–
DIFF_SSTL18_I	1.7	1.8	1.9	100	–	–	0.7	–	1.1
DIFF_SSTL18_II(8)	1.7	1.8	1.9	100	–	–	0.7	–	1.1
DIFF_SSTL2_I	2.3	2.5	2.7	100	–	–	1.0	–	1.5
DIFF_SSTL2_II(8)	2.3	2.5	2.7	100	–	–	1.0	–	1.5
DIFF_SSTL3_I	3.0	3.3	3.6	100	–	–	1.1	–	1.9
DIFF_SSTL3_II	3.0	3.3	3.6	100	–	–	1.1	–	1.9

Notes:

1. The V_{CCO} rails supply only differential output drivers, not input circuits.
2. V_{ICM} must be less than V_{CCAUX}.
3. These true differential output standards are supported only on FPGA banks 0 and 2. Inputs are unrestricted. See the chapter "Using I/O Resources" in UG331.
4. See "External Termination Requirements for Differential I/O," page 20.
5. LVPECL is supported on inputs only, not outputs. LVPECL_33 requires V_{CCAUX}=3.3V ± 10%.
6. LVPECL_33 maximum V_{ICM} = the lower of 2.8V or $V_{CCAUX} - (V_{ID} / 2)$
7. Requires V_{CCAUX} = 3.3V ± 10% for inputs. $(V_{CCAUX} - 300\ mV) \leq V_{ICM} \leq (V_{CCAUX} - 37\ mV)$
8. These higher-drive output standards are supported only on FPGA banks 1 and 3. Inputs are unrestricted. See the chapter "Using I/O Resources" in UG331.
9. All standards except for LVPECL and TMDS can have V_{CCAUX} at either 2.5V or 3.3V. Define your V_{CCAUX} level using the CONFIG VCCAUX constraint.

Table 22: **Propagation Times for the IOB Input Path *(Continued)***

Symbol	Description	Conditions	DELAY_VALUE	Device	Speed Grade		Units
					-5	-4	
					Max	Max	
T_{IOPID}	The time it takes for data to travel from the Input pin to the I output with the input delay programmed	LVCMOS25(2)	15	XC3S200A	5.43	6.24	ns
			16		5.75	6.59	ns
			1	XC3S400A	1.32	1.43	ns
			2		1.67	1.83	ns
			3		1.90	2.07	ns
			4		2.33	2.52	ns
			5		2.60	2.91	ns
			6		2.94	3.20	ns
			7		3.23	3.51	ns
			8		3.50	3.85	ns
			9		3.18	3.55	ns
			10		3.53	3.95	ns
			11		3.76	4.20	ns
			12		4.26	4.67	ns
			13		4.51	4.97	ns
			14		4.85	5.32	ns
			15		5.14	5.64	ns
			16		5.40	5.95	ns
			1	XC3S700A	1.84	1.87	ns
			2		2.20	2.27	ns
			3		2.46	2.60	ns
			4		2.93	3.15	ns
			5		3.21	3.45	ns
			6		3.54	3.80	ns
			7		3.86	4.16	ns
			8		4.13	4.48	ns
			9		3.82	4.19	ns
			10		4.17	4.58	ns
			11		4.43	4.89	ns
			12		4.95	5.49	ns
			13		5.22	5.83	ns
			14		5.57	6.21	ns
			15		5.89	6.55	ns
			16		6.16	6.89	ns
			1	XC3S1400A	1.95	2.18	ns
			2		2.29	2.59	ns
			3		2.54	2.84	ns
			4		2.96	3.30	ns

Input Timing Adjustments

Table 23: **Input Timing Adjustments by IOSTANDARD**

Convert Input Time from LVCMOS25 to the Following Signal Standard (IOSTANDARD)	Add the Adjustment Below		Units
	Speed Grade		
	-5	-4	
Single-Ended Standards			
LVTTL	0.62	0.62	ns
LVCMOS33	0.54	0.54	ns
LVCMOS25	0	0	ns
LVCMOS18	0.83	0.83	ns
LVCMOS15	0.60	0.60	ns
LVCMOS12	0.31	0.31	ns
PCI33_3	0.41	0.41	ns
PCI66_3	0.41	0.41	ns
HSTL_I	0.72	0.72	ns
HSTL_III	0.77	0.77	ns
HSTL_I_18	0.69	0.69	ns
HSTL_II_18	0.69	0.69	ns
HSTL_III_18	0.79	0.79	ns
SSTL18_I	0.71	0.71	ns
SSTL18_II	0.71	0.71	ns
SSTL2_I	0.68	0.68	ns
SSTL2_II	0.68	0.68	ns
SSTL3_I	0.78	0.78	ns
SSTL3_II	0.78	0.78	ns

Table 23: **Input Timing Adjustments by IOSTANDARD*(Continued)***

Convert Input Time from LVCMOS25 to the Following Signal Standard (IOSTANDARD)	Add the Adjustment Below		Units
	Speed Grade		
	-5	-4	
Differential Standards			
LVDS_25	0.76	0.76	ns
LVDS_33	0.79	0.79	ns
BLVDS_25	0.79	0.79	ns
MINI_LVDS_25	0.78	0.78	ns
MINI_LVDS_33	0.79	0.79	ns
LVPECL_25	0.78	0.78	ns
LVPECL_33	0.79	0.79	ns
RSDS_25	0.79	0.79	ns
RSDS_33	0.77	0.77	ns
TMDS_33	0.79	0.79	ns
PPDS_25	0.79	0.79	ns
PPDS_33	0.79	0.79	ns
DIFF_HSTL_I_18	0.74	0.74	ns
DIFF_HSTL_II_18	0.72	0.72	ns
DIFF_HSTL_III_18	1.05	1.05	ns
DIFF_HSTL_I	0.72	0.72	ns
DIFF_HSTL_III	1.05	1.05	ns
DIFF_SSTL18_I	0.71	0.71	ns
DIFF_SSTL18_II	0.71	0.71	ns
DIFF_SSTL2_I	0.74	0.74	ns
DIFF_SSTL2_II	0.75	0.75	ns
DIFF_SSTL3_I	1.06	1.06	ns
DIFF_SSTL3_II	1.06	1.06	ns

Notes:

1. The numbers in this table are tested using the methodology presented in Table 27 and are based on the operating conditions set forth in Table 8, Table 11, and Table 13.
2. These adjustments are used to convert input path times originally specified for the LVCMOS25 standard to times that correspond to other signal standards.

Output Propagation Times

Table 24: **Timing for the IOB Output Path**

Symbol	Description	Conditions	Device	Speed Grade		Units
				-5	-4	
				Max	Max	
Clock-to-Output Times						
T_{IOCKP}	When reading from the Output Flip-Flop (OFF), the time from the active transition at the OCLK input to data appearing at the Output pin	LVCMOS25(2), 12 mA output drive, Fast slew rate	All	2.87	3.13	ns
Propagation Times						
T_{IOOP}	The time it takes for data to travel from the IOB's O input to the Output pin	LVCMOS25(2), 12 mA output drive, Fast slew rate	All	2.78	2.91	ns
Set/Reset Times						
T_{IOSRP}	Time from asserting the OFF's SR input to setting/resetting data at the Output pin	LVCMOS25(2), 12 mA output drive, Fast slew rate	All	3.63	3.89	ns
T_{IOGSRQ}	Time from asserting the Global Set Reset (GSR) input on the STARTUP_SPARTAN3A primitive to setting/resetting data at the Output pin			8.62	9.65	ns

Notes:

1. The numbers in this table are tested using the methodology presented in Table 27 and are based on the operating conditions set forth in Table 8 and Table 11.
2. This time requires adjustment whenever a signal standard other than LVCMOS25 with 12 mA drive and Fast slew rate is assigned to the data Output. When this is true, *add* the appropriate Output adjustment from Table 26.

Three-State Output Propagation Times

Table 25: **Timing for the IOB Three-State Path**

Symbol	Description	Conditions	Device	Speed Grade		Units
				-5	-4	
				Max	Max	
Synchronous Output Enable/Disable Times						
T_{IOCKHZ}	Time from the active transition at the OTCLK input of the Three-state Flip-Flop (TFF) to when the Output pin enters the high-impedance state	LVCMOS25, 12 mA output drive, Fast slew rate	All	0.63	0.76	ns
T_{IOCKON}(2)	Time from the active transition at TFF's OTCLK input to when the Output pin drives valid data		All	2.80	3.06	ns
Asynchronous Output Enable/Disable Times						
T_{GTS}	Time from asserting the Global Three State (GTS) input on the STARTUP_SPARTAN3A primitive to when the Output pin enters the high-impedance state	LVCMOS25, 12 mA output drive, Fast slew rate	All	9.47	10.36	ns
Set/Reset Times						
T_{IOSRHZ}	Time from asserting TFF's SR input to when the Output pin enters a high-impedance state	LVCMOS25, 12 mA output drive, Fast slew rate	All	1.61	1.86	ns
T_{IOSRON}(2)	Time from asserting TFF's SR input at TFF to when the Output pin drives valid data		All	3.57	3.82	ns

Notes:

1. The numbers in this table are tested using the methodology presented in Table 27 and are based on the operating conditions set forth in Table 8 and Table 11.
2. This time requires adjustment whenever a signal standard other than LVCMOS25 with 12 mA drive and Fast slew rate is assigned to the data Output. When this is true, *add* the appropriate Output adjustment from Table 26.

Output Timing Adjustments

Table 26: **Output Timing Adjustments for IOB**

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
Single-Ended Standards					
LVTTL	Slow	2 mA	5.58	5.58	ns
		4 mA	3.16	3.16	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.62	1.62	ns
		16 mA	1.24	1.24	ns
		24 mA	2.74(3)	2.74(3)	ns
	Fast	2 mA	3.03	3.03	ns
		4 mA	1.71	1.71	ns
		6 mA	1.71	1.71	ns
		8 mA	0.53	0.53	ns
		12 mA	0.53	0.53	ns
		16 mA	0.59	0.59	ns
		24 mA	0.60	0.60	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.67	16.67	ns
		16 mA	16.22	16.22	ns
		24 mA	12.11	12.11	ns

Table 26: **Output Timing Adjustments for IOB*(Continued)***

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS33	Slow	2 mA	5.58	5.58	ns
		4 mA	3.17	3.17	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.24	1.24	ns
		16 mA	1.15	1.15	ns
		24 mA	2.55(3)	2.55(3)	ns
	Fast	2 mA	3.02	3.02	ns
		4 mA	1.71	1.71	ns
		6 mA	1.72	1.72	ns
		8 mA	0.53	0.53	ns
		12 mA	0.59	0.59	ns
		16 mA	0.59	0.59	ns
		24 mA	0.51	0.51	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.29	16.29	ns
		16 mA	16.18	16.18	ns
		24 mA	12.11	12.11	ns

Table 26: **Output Timing Adjustments for IOB*(Continued)***

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS25	Slow	2 mA	5.33	5.33	ns
		4 mA	2.81	2.81	ns
		6 mA	2.82	2.82	ns
		8 mA	1.14	1.14	ns
		12 mA	1.10	1.10	ns
		16 mA	0.83	0.83	ns
		24 mA	2.26(3)	2.26(3)	ns
	Fast	2 mA	4.36	4.36	ns
		4 mA	1.76	1.76	ns
		6 mA	1.25	1.25	ns
		8 mA	0.38	0.38	ns
		12 mA	0	0	ns
		16 mA	0.01	0.01	ns
		24 mA	0.01	0.01	ns
	QuietIO	2 mA	25.92	25.92	ns
		4 mA	25.92	25.92	ns
		6 mA	25.92	25.92	ns
		8 mA	15.57	15.57	ns
		12 mA	15.59	15.59	ns
		16 mA	14.27	14.27	ns
		24 mA	11.37	11.37	ns
LVCMOS18	Slow	2 mA	4.48	4.48	ns
		4 mA	3.69	3.69	ns
		6 mA	2.91	2.91	ns
		8 mA	1.99	1.99	ns
		12 mA	1.57	1.57	ns
		16 mA	1.19	1.19	ns
	Fast	2 mA	3.96	3.96	ns
		4 mA	2.57	2.57	ns
		6 mA	1.90	1.90	ns
		8 mA	1.06	1.06	ns
		12 mA	0.83	0.83	ns
		16 mA	0.63	0.63	ns
	QuietIO	2 mA	24.97	24.97	ns
		4 mA	24.97	24.97	ns
		6 mA	24.08	24.08	ns
		8 mA	16.43	16.43	ns
		12 mA	14.52	14.52	ns
		16 mA	13.41	13.41	ns

Table 26: **Output Timing Adjustments for IOB*(Continued)***

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS15	Slow	2 mA	5.82	5.82	ns
		4 mA	3.97	3.97	ns
		6 mA	3.21	3.21	ns
		8 mA	2.53	2.53	ns
		12 mA	2.06	2.06	ns
	Fast	2 mA	5.23	5.23	ns
		4 mA	3.05	3.05	ns
		6 mA	1.95	1.95	ns
		8 mA	1.60	1.60	ns
		12 mA	1.30	1.30	ns
	QuietIO	2 mA	34.11	34.11	ns
		4 mA	25.66	25.66	ns
		6 mA	24.64	24.64	ns
		8 mA	22.06	22.06	ns
		12 mA	20.64	20.64	ns
LVCMOS12	Slow	2 mA	7.14	7.14	ns
		4 mA	4.87	4.87	ns
		6 mA	5.67	5.67	ns
	Fast	2 mA	6.77	6.77	ns
		4 mA	5.02	5.02	ns
		6 mA	4.09	4.09	ns
	QuietIO	2 mA	50.76	50.76	ns
		4 mA	43.17	43.17	ns
		6 mA	37.31	37.31	ns
PCI33_3			0.34	0.34	ns
PCI66_3			0.34	0.34	ns
HSTL_I			0.78	0.78	ns
HSTL_III			1.16	1.16	ns
HSTL_I_18			0.35	0.35	ns
HSTL_II_18			0.30	0.30	ns
HSTL_III_18			0.47	0.47	ns
SSTL18_I			0.40	0.40	ns
SSTL18_II			0.30	0.30	ns
SSTL2_I			0	0	ns
SSTL2_II			–0.05	–0.05	ns
SSTL3_I			0	0	ns
SSTL3_II			0.17	0.17	ns

Table 27: **Test Methods for Timing Measurement at I/Os*(Continued)***

Signal Standard (IOSTANDARD)	Inputs			Outputs		Inputs and Outputs
	V_{REF} (V)	V_L (V)	V_H (V)	R_T (Ω)	V_T (V)	V_M (V)
Differential						
LVDS_25	-	V_{ICM} – 0.125	V_{ICM} + 0.125	50	1.2	V_{ICM}
LVDS_33	-	V_{ICM} – 0.125	V_{ICM} + 0.125	50	1.2	V_{ICM}
BLVDS_25	-	V_{ICM} – 0.125	V_{ICM} + 0.125	1M	0	V_{ICM}
MINI_LVDS_25	-	V_{ICM} – 0.125	V_{ICM} + 0.125	50	1.2	V_{ICM}
MINI_LVDS_33	-	V_{ICM} – 0.125	V_{ICM} + 0.125	50	1.2	V_{ICM}
LVPECL_25	-	V_{ICM} – 0.3	V_{ICM} + 0.3	N/A	N/A	V_{ICM}
LVPECL_33	-	V_{ICM} – 0.3	V_{ICM} + 0.3	N/A	N/A	V_{ICM}
RSDS_25	-	V_{ICM} – 0.1	V_{ICM} + 0.1	50	1.2	V_{ICM}
RSDS_33	-	V_{ICM} – 0.1	V_{ICM} + 0.1	50	1.2	V_{ICM}
TMDS_33	-	V_{ICM} – 0.1	V_{ICM} + 0.1	50	3.3	V_{ICM}
PPDS_25	-	V_{ICM} – 0.1	V_{ICM} + 0.1	50	0.8	V_{ICM}
PPDS_33	-	V_{ICM} – 0.1	V_{ICM} + 0.1	50	0.8	V_{ICM}
DIFF_HSTL_I	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	0.75	V_{ICM}
DIFF_HSTL_III	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	1.5	V_{ICM}
DIFF_HSTL_I_18	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	0.9	V_{ICM}
DIFF_HSTL_II_18	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	0.9	V_{ICM}
DIFF_HSTL_III_18	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	1.8	V_{ICM}
DIFF_SSTL18_I	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	0.9	V_{ICM}
DIFF_SSTL18_II	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	0.9	V_{ICM}
DIFF_SSTL2_I	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	1.25	V_{ICM}
DIFF_SSTL2_II	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	1.25	V_{ICM}
DIFF_SSTL3_I	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	1.5	V_{ICM}
DIFF_SSTL3_II	-	V_{ICM} – 0.5	V_{ICM} + 0.5	50	1.5	V_{ICM}

Notes:

1. Descriptions of the relevant symbols are as follows:
   V_{REF} – The reference voltage for setting the input switching threshold
   V_{ICM} – The common mode input voltage
   V_M – Voltage of measurement point on signal transition
   V_L – Low-level test voltage at Input pin
   V_H – High-level test voltage at Input pin
   R_T – Effective termination resistance, which takes on a value of 1 MΩ when no parallel termination is required
   V_T – Termination voltage
2. The load capacitance (C_L) at the Output pin is 0 pF for all signal standards.
3. According to the PCI specification.

The capacitive load (C_L) is connected between the output and GND. *The Output timing for all standards, as published in the speed files and the data sheet, is always based on a C_L value of zero*. High-impedance probes (less than 1 pF) are used for all measurements. Any delay that the test fixture might contribute to test measurements is subtracted from those measurements to produce the final timing numbers as published in the speed files and data sheet.

Table 28: **Equivalent V_{CCO}/GND Pairs per Bank**

Device	Package Style *(including Pb-free)*						
	VQ100	TQ144	FT256	FG320	FG400	FG484	FG676
XC3S50A	1	2	3	–	–	–	–
XC3S200A	1	–	4	4	–	–	–
XC3S400A	–	–	4	4	5	–	–
XC3S700A	–	–	4	–	5	5	–
XC3S1400A	–	–	4	–	–	6	9

Table 29: **Recommended Number of Simultaneously Switching Outputs per VCCO-GND Pair (V_{CCAUX}=3.3V)**

Signal Standard (IOSTANDARD)			Package Type			
			VQ100, TQ144		FT256, FG320, FG400, FG484, FG676	
			Top, Bottom (Banks 0,2)	Left, Right (Banks 1,3)	Top, Bottom (Banks 0,2)	Left, Right (Banks 1,3)
Single-Ended Standards						
LVTTL	Slow	2	20	20	60	60
		4	10	10	41	41
		6	10	10	29	29
		8	6	6	22	22
		12	6	6	13	13
		16	5	5	11	11
		24	4	4	9	9
	Fast	2	10	10	10	10
		4	6	6	6	6
		6	5	5	5	5
		8	3	3	3	3
		12	3	3	3	3
		16	3	3	3	3
		24	2	2	2	2
	QuietIO	2	40	40	80	80
		4	24	24	48	48
		6	20	20	36	36
		8	16	16	27	27
		12	12	12	16	16
		16	9	9	13	13
		24	9	9	12	12

Table 29: **Recommended Number of Simultaneously Switching Outputs per VCCO-GND Pair (V_{CCAUX}=3.3V)*(Continued)***

Signal Standard (IOSTANDARD)			Package Type			
			VQ100, TQ144		FT256, FG320, FG400, FG484, FG676	
			Top, Bottom (Banks 0,2)	Left, Right (Banks 1,3)	Top, Bottom (Banks 0,2)	Left, Right (Banks 1,3)
LVCMOS33	Slow	2	24	24	76	76
		4	14	14	46	46
		6	11	11	27	27
		8	10	10	20	20
		12	9	9	13	13
		16	8	8	10	10
		24	–	8	–	9
	Fast	2	10	10	10	10
		4	8	8	8	8
		6	5	5	5	5
		8	4	4	4	4
		12	4	4	4	4
		16	2	2	2	2
		24	–	2	–	2
	QuietIO	2	36	36	76	76
		4	32	32	46	46
		6	24	24	32	32
		8	16	16	26	26
		12	16	16	18	18
		16	12	12	14	14
		24	–	10	–	10

Digital Clock Manager (DCM) Timing

For specification purposes, the DCM consists of three key components: the Delay-Locked Loop (DLL), the Digital Frequency Synthesizer (DFS), and the Phase Shifter (PS).

Aspects of DLL operation play a role in all DCM applications. All such applications inevitably use the CLKIN and the CLKFB inputs connected to either the CLK0 or the CLK2X feedback, respectively. Thus, specifications in the DLL tables (Table 36 and Table 37) apply to any application that only employs the DLL component. When the DFS and/or the PS components are used together with the DLL, then the specifications listed in the DFS and PS tables (Table 38 through Table 41) supersede any corresponding ones in the DLL tables. DLL specifications that do not change with the addition of DFS or PS functions are presented in Table 36 and Table 37.

Period jitter and cycle-cycle jitter are two of many different ways of specifying clock jitter. Both specifications describe statistical variation from a mean value.

Period jitter is the worst-case deviation from the ideal clock period over a collection of millions of samples. In a histogram of period jitter, the mean value is the clock period.

Cycle-cycle jitter is the worst-case difference in clock period between adjacent clock cycles in the collection of clock periods sampled. In a histogram of cycle-cycle jitter, the mean value is zero.

Spread Spectrum

DCMs accept typical spread spectrum clocks as long as they meet the input requirements. The DLL will track the frequency changes created by the spread spectrum clock to drive the global clocks to the FPGA logic. See XAPP469, *Spread-Spectrum Clocking Reception for Displays* for details.

Delay-Locked Loop (DLL)

Table 36: **Recommended Operating Conditions for the DLL**

Symbol		Description		Speed Grade				Units
				-5		-4		
				Min	Max	Min	Max	
Input Frequency Ranges								
F_{CLKIN}	CLKIN_FREQ_DLL	Frequency of the CLKIN clock input		5(2)	280(3)	5(2)	250(3)	MHz
Input Pulse Requirements								
CLKIN_PULSE		CLKIN pulse width as a percentage of the CLKIN period	$F_{CLKIN} \leq 150$ MHz	40%	60%	40%	60%	–
			$F_{CLKIN} > 150$ MHz	45%	55%	45%	55%	–
Input Clock Jitter Tolerance and Delay Path Variation(4)								
CLKIN_CYC_JITT_DLL_LF		Cycle-to-cycle jitter at the CLKIN input	$F_{CLKIN} \leq 150$ MHz	–	±300	–	±300	ps
CLKIN_CYC_JITT_DLL_HF			$F_{CLKIN} > 150$ MHz	–	±150	–	±150	ps
CLKIN_PER_JITT_DLL		Period jitter at the CLKIN input		–	±1	–	±1	ns
CLKFB_DELAY_VAR_EXT		Allowable variation of off-chip feedback delay from the DCM output to the CLKFB input		–	±1	–	±1	ns

Notes:

1. DLL specifications apply when any of the DLL outputs (CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, or CLKDV) are in use.
2. The DFS, when operating independently of the DLL, supports lower FCLKIN frequencies. See Table 38.
3. To support double the maximum effective FCLKIN limit, set the CLKIN_DIVIDE_BY_2 attribute to TRUE. This attribute divides the incoming clock frequency by two as it enters the DCM. The CLK2X output reproduces the clock frequency provided on the CLKIN input.
4. CLKIN input jitter beyond these limits might cause the DCM to lose lock.
5. The DCM specifications are guaranteed when both adjacent DCMs are locked.

Table 39: **Switching Characteristics for the DFS*(Continued)***

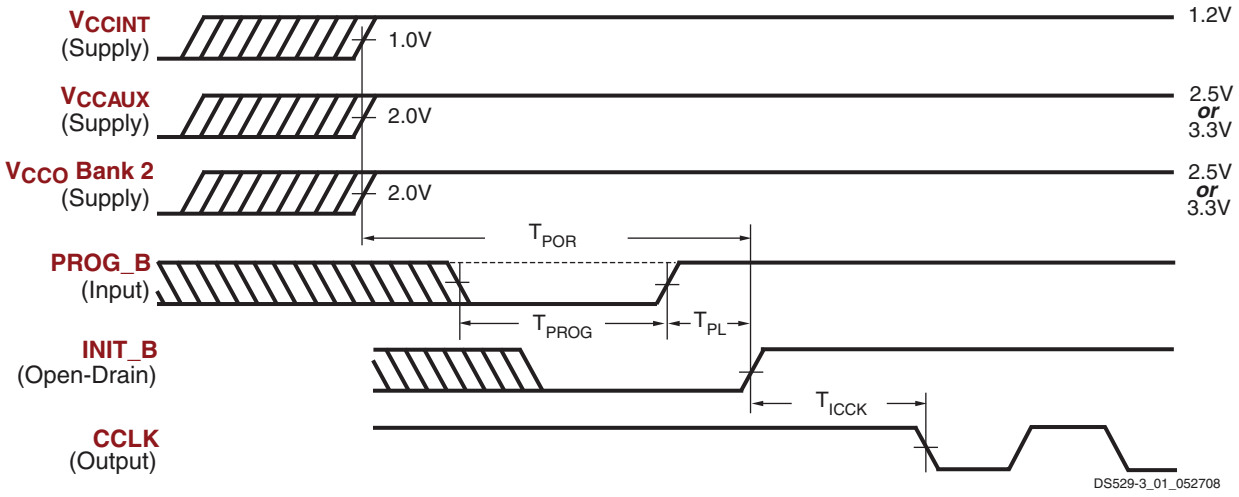
Symbol	Description		Device	Speed Grade				Units
				-5		-4		
				Min	Max	Min	Max	
Lock Time								
LOCK_FX[2, 3]	The time from deassertion at the DCM's Reset input to the rising transition at its LOCKED output. The DFS asserts LOCKED when the CLKFX and CLKFX180 signals are valid. If using both the DLL and the DFS, use the longer locking time.	5 MHz ≤ F_{CLKIN} ≤ 15 MHz	All	–	5	–	5	ms
		F_{CLKIN} > 15 MHz		–	450	–	450	µs

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8 and Table 38.
2. DFS performance requires the additional logic automatically added by ISE 9.1i and later software revisions.
3. For optimal jitter tolerance and faster lock time, use the CLKIN_PERIOD attribute.
4. Maximum output jitter is characterized within a reasonable noise environment (150 ps input period jitter, 40 SSOs and 25% CLB switching) on an XC3S1400A FPGA. Output jitter strongly depends on the environment, including the number of SSOs, the output drive strength, CLB utilization, CLB switching activities, switching frequency, power supply and PCB design. The actual maximum output jitter depends on the system application.
5. The CLKFX and CLKFX180 outputs always have an approximate 50% duty cycle.
6. Some duty-cycle and alignment specifications include a percentage of the CLKFX output period. For example, the data sheet specifies a maximum CLKFX jitter of "±[1% of CLKFX period + 200]". Assume the CLKFX output frequency is 100 MHz. The equivalent CLKFX period is 10 ns and 1% of 10 ns is 0.1 ns or 100 ps. According to the data sheet, the maximum jitter is ±[100 ps + 200 ps] = ±300 ps.

Configuration and JTAG Timing

General Configuration Power-On/Reconfigure Timing



Notes:

1. The V_{CCINT}, V_{CCAUX}, and V_{CCO} supplies can be applied in any order.
2. The Low-going pulse on PROG_B is optional after power-on but necessary for reconfiguration without a power cycle.
3. The rising edge of INIT_B samples the voltage levels applied to the mode pins (M0 - M2).

Figure 11: **Waveforms for Power-On and the Beginning of Configuration**

Table 45: **Power-On Timing and the Beginning of Configuration**

Symbol	Description	Device	All Speed Grades		Units
			Min	Max	
T_{POR}(2)	The time from the application of V_{CCINT}, V_{CCAUX}, and V_{CCO} Bank 2 supply voltage ramps (whichever occurs last) to the rising transition of the INIT_B pin	All	–	18	ms
T_{PROG}	The width of the low-going pulse on the PROG_B pin	All	0.5	-	µs
T_{PL}(2)	The time from the rising edge of the PROG_B pin to the rising transition on the INIT_B pin	XC3S50A	–	0.5	ms
		XC3S200A	–	0.5	ms
		XC3S400A	–	1	ms
		XC3S700A	–	2	ms
		XC3S1400A	–	2	ms
T_{INIT}	Minimum Low pulse width on INIT_B output	All	250	–	ns
T_{ICCK}(3)	The time from the rising edge of the INIT_B pin to the generation of the configuration clock signal at the CCLK output pin	All	0.5	4	µs

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8. This means power must be applied to all V_{CCINT}, V_{CCO}, and V_{CCAUX} lines.
2. Power-on reset and the clearing of configuration memory occurs during this period.
3. This specification applies only to the Master Serial, SPI, and BPI modes.
4. For details on configuration, see UG332 *Spartan-3 Generation Configuration User Guide*.

Table 77: **Spartan-3A FG320 Pinout *(Continued)***

Bank	Pin Name	FG320 Ball	Type
GND	GND	R15	GND
GND	GND	T9	GND
GND	GND	V1	GND
GND	GND	V7	GND
GND	GND	V12	GND
GND	GND	V18	GND
VCCAUX	SUSPEND	T16	PWR MGMT
VCCAUX	DONE	V17	CONFIG
VCCAUX	PROG_B	C4	CONFIG
VCCAUX	TCK	A17	JTAG
VCCAUX	TDI	E4	JTAG
VCCAUX	TDO	E14	JTAG
VCCAUX	TMS	C3	JTAG
VCCAUX	VCCAUX	A9	VCCAUX
VCCAUX	VCCAUX	G10	VCCAUX
VCCAUX	VCCAUX	J12	VCCAUX
VCCAUX	VCCAUX	J18	VCCAUX
VCCAUX	VCCAUX	K1	VCCAUX
VCCAUX	VCCAUX	K7	VCCAUX
VCCAUX	VCCAUX	M10	VCCAUX
VCCAUX	VCCAUX	V10	VCCAUX
VCCINT	VCCINT	H9	VCCINT
VCCINT	VCCINT	H11	VCCINT
VCCINT	VCCINT	J8	VCCINT
VCCINT	VCCINT	K11	VCCINT
VCCINT	VCCINT	L8	VCCINT
VCCINT	VCCINT	L10	VCCINT

FG484: 484-ball Fine-pitch Ball Grid Array

The 484-ball fine-pitch ball grid array, FG484, supports both the XC3S700A and the XC3S1400A FPGAs. There are three pinout differences, as described in Table 86.

Table 83 lists all the FG484 package pins. They are sorted by bank number and then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The shaded rows indicate pinout differences between the XC3S700A and the XC3S1400A FPGAs. The XC3S700A has three unconnected balls, indicated as N.C. (No Connection) in Table 83 and with the black diamond character (◆) in Table 83 and Figure 25.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 83: **Spartan-3A FG484 Pinout**

Bank	Pin Name	FG484 Ball	Type
0	IO_L01N_0	D18	I/O
0	IO_L01P_0	E17	I/O
0	IO_L02N_0	C19	I/O
0	IO_L02P_0/VREF_0	D19	VREF
0	IO_L03N_0	A20	I/O
0	IO_L03P_0	B20	I/O
0	IO_L04N_0	F15	I/O
0	IO_L04P_0	E15	I/O
0	IO_L05N_0	A18	I/O
0	IO_L05P_0	C18	I/O
0	IO_L06N_0	A19	I/O
0	IO_L06P_0/VREF_0	B19	VREF
0	IO_L07N_0	C17	I/O
0	IO_L07P_0	D17	I/O
0	IO_L08N_0	C16	I/O
0	IO_L08P_0	D16	I/O
0	IO_L09N_0	E14	I/O
0	IO_L09P_0	C14	I/O
0	IO_L10N_0	A17	I/O
0	IO_L10P_0	B17	I/O
0	IO_L11N_0	C15	I/O
0	IO_L11P_0	D15	I/O
0	IO_L12N_0/VREF_0	A15	VREF
0	IO_L12P_0	A16	I/O
0	IO_L13N_0	A14	I/O
0	IO_L13P_0	B15	I/O
0	IO_L14N_0	E13	I/O
0	IO_L14P_0	F13	I/O
0	IO_L15N_0	C13	I/O
0	IO_L15P_0	D13	I/O
0	IO_L16N_0	A13	I/O
0	IO_L16P_0	B13	I/O
0	IO_L17N_0/GCLK5	E12	GCLK
0	IO_L17P_0/GCLK4	C12	GCLK
0	IO_L18N_0/GCLK7	A11	GCLK
0	IO_L18P_0/GCLK6	A12	GCLK
0	IO_L19N_0/GCLK9	C11	GCLK
0	IO_L19P_0/GCLK8	B11	GCLK
0	IO_L20N_0/GCLK11	E11	GCLK
0	IO_L20P_0/GCLK10	D11	GCLK
0	IO_L21N_0	C10	I/O
0	IO_L21P_0	A10	I/O
0	IO_L22N_0	A8	I/O
0	IO_L22P_0	A9	I/O
0	IO_L23N_0	E10	I/O
0	IO_L23P_0	D10	I/O
0	IO_L24N_0/VREF_0	C9	VREF
0	IO_L24P_0	B9	I/O
0	IO_L25N_0	C8	I/O
0	IO_L25P_0	B8	I/O
0	IO_L26N_0	A6	I/O
0	IO_L26P_0	A7	I/O
0	IO_L27N_0	C7	I/O
0	IO_L27P_0	D7	I/O
0	IO_L28N_0	A5	I/O
0	IO_L28P_0	B6	I/O
0	IO_L29N_0	D6	I/O
0	IO_L29P_0	C6	I/O
0	IO_L30N_0	D8	I/O

Table 83: **Spartan-3A FG484 Pinout *(Continued)***

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
0	IO_L30P_0	E9	I/O
0	IO_L31N_0	B4	I/O
0	IO_L31P_0	A4	I/O
0	IO_L32N_0	D5	I/O
0	IO_L32P_0	C5	I/O
0	IO_L33N_0	B3	I/O
0	IO_L33P_0	A3	I/O
0	IO_L34N_0	F8	I/O
0	IO_L34P_0	E7	I/O
0	IO_L35N_0	E6	I/O
0	IO_L35P_0	F7	I/O
0	IO_L36N_0/PUDC_B	A2	DUAL
0	IO_L36P_0/VREF_0	B2	VREF
0	IP_0	E16	INPUT
0	IP_0	E8	INPUT
0	IP_0	F10	INPUT
0	IP_0	F12	INPUT
0	IP_0	F16	INPUT
0	IP_0	G10	INPUT
0	IP_0	G11	INPUT
0	IP_0	G12	INPUT
0	IP_0	G13	INPUT
0	IP_0	G14	INPUT
0	IP_0	G15	INPUT
0	IP_0	G16	INPUT
0	IP_0	G7	INPUT
0	IP_0	G9	INPUT
0	IP_0	H10	INPUT
0	IP_0	H13	INPUT
0	IP_0	H14	INPUT
0	IP_0/VREF_0	G8	VREF
0	IP_0/VREF_0	H12	VREF
0	IP_0/VREF_0	H9	VREF
0	VCCO_0	B10	VCCO
0	VCCO_0	B14	VCCO
0	VCCO_0	B18	VCCO
0	VCCO_0	B5	VCCO
0	VCCO_0	F14	VCCO
0	VCCO_0	F9	VCCO
1	IO_L01N_1/LDC2	Y21	DUAL

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
1	IO_L01P_1/HDC	AA22	DUAL
1	IO_L02N_1/LDC0	W20	DUAL
1	IO_L02P_1/LDC1	W19	DUAL
1	IO_L03N_1/A1	T18	DUAL
1	IO_L03P_1/A0	T17	DUAL
1	IO_L05N_1	W21	I/O
1	IO_L05P_1	Y22	I/O
1	IO_L06N_1	V20	I/O
1	IO_L06P_1	V19	I/O
1	IO_L07N_1	V22	I/O
1	IO_L07P_1	W22	I/O
1	IO_L09N_1	U21	I/O
1	IO_L09P_1	U22	I/O
1	IO_L10N_1	U19	I/O
1	IO_L10P_1	U20	I/O
1	IO_L11N_1	T22	I/O
1	IO_L11P_1	T20	I/O
1	IO_L13N_1	T19	I/O
1	IO_L13P_1	R20	I/O
1	IO_L14N_1	R22	I/O
1	IO_L14P_1	R21	I/O
1	IO_L15N_1/VREF_1	P22	VREF
1	IO_L15P_1	P20	I/O
1	IO_L17N_1/A3	P18	DUAL
1	IO_L17P_1/A2	R19	DUAL
1	IO_L18N_1/A5	N21	DUAL
1	IO_L18P_1/A4	N22	DUAL
1	IO_L19N_1/A7	N19	DUAL
1	IO_L19P_1/A6	N20	DUAL
1	IO_L20N_1/A9	N17	DUAL
1	IO_L20P_1/A8	N18	DUAL
1	IO_L21N_1/RHCLK1	L22	RHCLK
1	IO_L21P_1/RHCLK0	M22	RHCLK
1	IO_L22N_1/TRDY1/RHCLK3	L20	RHCLK
1	IO_L22P_1/RHCLK2	L21	RHCLK
1	IO_L24N_1/RHCLK5	M20	RHCLK
1	IO_L24P_1/RHCLK4	M18	RHCLK
1	IO_L25N_1/RHCLK7	K19	RHCLK
1	IO_L25P_1/IRDY1/RHCLK6	K20	RHCLK
1	IO_L26N_1/A11	J22	DUAL

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
2	IO_L10P_2	Y7	I/O
2	IO_L11N_2/VS0	Y8	DUAL
2	IO_L11P_2/VS1	W8	DUAL
2	IO_L12N_2	AB8	I/O
2	IO_L12P_2	AA8	I/O
2	IO_L13N_2	Y10	I/O
2	IO_L13P_2	V10	I/O
2	IO_L14N_2/D6	AB9	DUAL
2	IO_L14P_2/D7	Y9	DUAL
2	IO_L15N_2	AB10	I/O
2	IO_L15P_2	AA10	I/O
2	IO_L16N_2/D4	AB11	DUAL
2	IO_L16P_2/D5	Y11	DUAL
2	IO_L17N_2/GCLK13	V11	GCLK
2	IO_L17P_2/GCLK12	U11	GCLK
2	IO_L18N_2/GCLK15	Y12	GCLK
2	IO_L18P_2/GCLK14	W12	GCLK
2	IO_L19N_2/GCLK1	AB12	GCLK
2	IO_L19P_2/GCLK0	AA12	GCLK
2	IO_L20N_2/GCLK3	U12	GCLK
2	IO_L20P_2/GCLK2	V12	GCLK
2	IO_L21N_2	Y13	I/O
2	IO_L21P_2	AB13	I/O
2	IO_L22N_2/MOSI/CSI_B	AB14	DUAL
2	IO_L22P_2	AA14	I/O
2	IO_L23N_2	Y14	I/O
2	IO_L23P_2	W13	I/O
2	IO_L24N_2/ DOUT	AA15	DUAL
2	IO_L24P_2/AWAKE	AB15	PWR MGMT
2	IO_L25N_2	Y15	I/O
2	IO_L25P_2	W15	I/O
2	IO_L26N_2/D3	U13	DUAL
2	IO_L26P_2/INIT_B	V13	DUAL
2	IO_L27N_2	Y16	I/O
2	IO_L27P_2	AB16	I/O
2	IO_L28N_2/D1	Y17	DUAL
2	IO_L28P_2/D2	AA17	DUAL
2	IO_L29N_2	AB18	I/O
2	IO_L29P_2	AB17	I/O

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
2	IO_L30N_2	V15	I/O
2	IO_L30P_2	V14	I/O
2	IO_L31N_2	V16	I/O
2	IO_L31P_2	W16	I/O
2	IO_L32N_2	AA19	I/O
2	IO_L32P_2	AB19	I/O
2	IO_L33N_2	V17	I/O
2	IO_L33P_2	W18	I/O
2	IO_L34N_2	W17	I/O
2	IO_L34P_2	Y18	I/O
2	IO_L35N_2	AA21	I/O
2	IO_L35P_2	AB21	I/O
2	IO_L36N_2/CCLK	AA20	DUAL
2	IO_L36P_2/D0/DIN/MISO	AB20	DUAL
2	IP_2	P12	INPUT
2	IP_2	R10	INPUT
2	IP_2	R11	INPUT
2	IP_2	R9	INPUT
2	IP_2	T13	INPUT
2	IP_2	T14	INPUT
2	IP_2	T9	INPUT
2	IP_2	U10	INPUT
2	IP_2	U15	INPUT
2	***XC3S1400A:*** IP_2 ***XC3S700A:*** N.C. (◆)	U16	INPUT
2	***XC3S1400A:*** IP_2 ***XC3S700A:*** N.C. (◆)	U7	INPUT
2	IP_2	U8	INPUT
2	IP_2	V7	INPUT
2	IP_2/VREF_2	R12	VREF
2	IP_2/VREF_2	R13	VREF
2	IP_2/VREF_2	R14	VREF
2	IP_2/VREF_2	T10	VREF
2	IP_2/VREF_2	T11	VREF
2	IP_2/VREF_2	T15	VREF
2	IP_2/VREF_2	T16	VREF
2	IP_2/VREF_2	T7	VREF
2	***XC3S1400A:*** IP_2/VREF_2 ***XC3S700A:*** N.C. (◆)	T8	VREF
2	IP_2/VREF_2	V8	VREF
2	VCCO_2	AA13	VCCO

Right Half of FG484 Package (Top View)

Figure 26:

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
3	IP_L58P_3	AA4	INPUT
3	IP_L62N_3	AB4	INPUT
3	IP_L62P_3	AB3	INPUT
3	IP_L66N_3/VREF_3	AE2	VREF
3	IP_L66P_3	AE1	INPUT
3	VCCO_3	AB2	VCCO
3	VCCO_3	E2	VCCO
3	VCCO_3	H5	VCCO
3	VCCO_3	L2	VCCO
3	VCCO_3	L8	VCCO
3	VCCO_3	P5	VCCO
3	VCCO_3	T2	VCCO
3	VCCO_3	T8	VCCO
3	VCCO_3	W5	VCCO
GND	GND	A1	GND
GND	GND	A6	GND
GND	GND	A11	GND
GND	GND	A16	GND
GND	GND	A21	GND
GND	GND	A26	GND
GND	GND	AA1	GND
GND	GND	AA6	GND
GND	GND	AA11	GND
GND	GND	AA16	GND
GND	GND	AA21	GND
GND	GND	AA26	GND
GND	GND	AD3	GND
GND	GND	AD8	GND
GND	GND	AD13	GND
GND	GND	AD18	GND
GND	GND	AD24	GND
GND	GND	AF1	GND
GND	GND	AF6	GND
GND	GND	AF11	GND
GND	GND	AF16	GND
GND	GND	AF21	GND
GND	GND	AF26	GND
GND	GND	C3	GND
GND	GND	C9	GND
GND	GND	C14	GND

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
GND	GND	C19	GND
GND	GND	C24	GND
GND	GND	F1	GND
GND	GND	F6	GND
GND	GND	F11	GND
GND	GND	F16	GND
GND	GND	F21	GND
GND	GND	F26	GND
GND	GND	H3	GND
GND	GND	H8	GND
GND	GND	H14	GND
GND	GND	H19	GND
GND	GND	J24	GND
GND	GND	K10	GND
GND	GND	K17	GND
GND	GND	L1	GND
GND	GND	L6	GND
GND	GND	L11	GND
GND	GND	L13	GND
GND	GND	L15	GND
GND	GND	L21	GND
GND	GND	L26	GND
GND	GND	M12	GND
GND	GND	M14	GND
GND	GND	M16	GND
GND	GND	N3	GND
GND	GND	N8	GND
GND	GND	N11	GND
GND	GND	N15	GND
GND	GND	P12	GND
GND	GND	P16	GND
GND	GND	P19	GND
GND	GND	P24	GND
GND	GND	R11	GND
GND	GND	R13	GND
GND	GND	R15	GND
GND	GND	T1	GND
GND	GND	T6	GND
GND	GND	T12	GND
GND	GND	T14	GND